Silicon N Channel MOS FET High Speed Power Switching

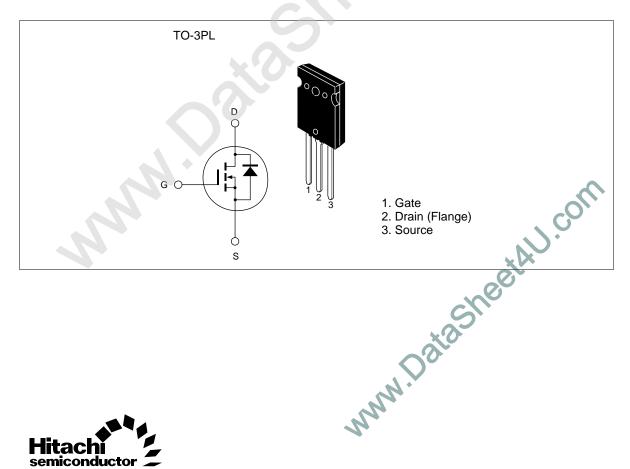
HITACHI

ADE-208-1381 (Z) Target Specification 1st. Edition Mar. 2001

Features

- Low on-resistance: $R_{DS(on)} = 0.09$ typ.
- Low leakage current: $IDSS = 10 \ \mu A \ max$ (at $VDS = 500 \ V$)
- High speed switching: tf = 280 ns typ (at VGS = 10 V, VDD = 250 V, ID = 25 A)
- Low gate charge: Qg = 220 nC typ (at VDD = 400 V, VGS = 10 V, ID = 50 A)
- Avalanche ratings
- Built-in fast recovery diode: trr = 190 ns typ

Outline



Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	500	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	50	A
Drain peak current	D (pulse)	200	A
Body-drain diode reverse drain current	I _{DR}	50	A
Body-drain diode reverse drain peak current	Note1 DR (pulse)	200	A
Avalanche current	AP Note3	15	A
Channel dissipation	Pch Note2	250	W
Channel to case Thermal Impedance	θ ch-c	0.5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Notes: 1. PW 10 µs, duty cycle 1%

2. Value at Tc = 25°C

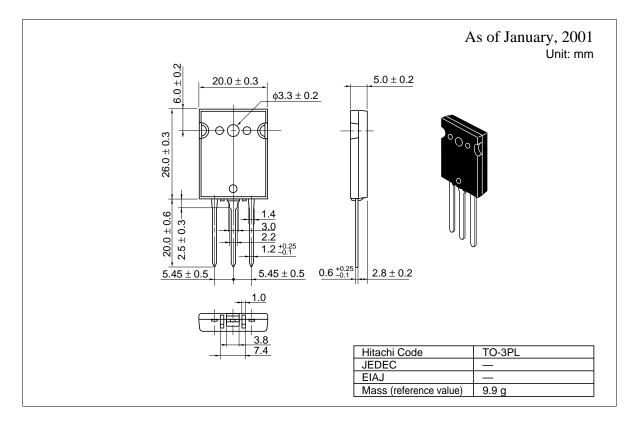
3. Tch 150°C

Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Мах	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	500	_	_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
Gate to source leak current	I _{GSS}	—	—	±0.1	μA	$V_{GS} = \pm 30$ V, $V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	_	10	μΑ	$V_{\rm DS} = 500 \text{ V}, V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	2.0	_	4.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.09	0.11		$I_{\rm D}$ = 25 A, $V_{\rm GS}$ = 10 V $^{\rm Note4}$
Forward transfer admittance	y _{fs}	27	45	_	S	$I_{\rm D} = 25$ A, $V_{\rm DS} = 10$ V ^{Note4}
Input capacitance	Ciss	_	7630		pF	V _{DS} = 25 V
Output capacitance	Coss	_	770		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	160		pF	f = 1 MHz
Turn-on delay time	td(on)	_	90		ns	I _D = 25 A
Rise time	tr	_	340		ns	V _{GS} = 10 V
Turn-off delay time	td(off)	_	370		ns	R _L = 10
Fall time	tf	_	280		ns	Rg = 10
Total gate charge	Qg	_	220		nC	V _{DD} = 400 V
Gate to source charge	Qgs	_	30		nC	V _{GS} = 10 V
Gate to drain charge	Qgd	_	110		nC	I _D = 50 A
Body-drain diode forward voltage	V_{DF}	—	0.98	1.5	V	$I_{F} = 50 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	trr	—	190	—	ns	$I_{\rm F} = 50 \text{ A}, V_{\rm GS} = 0$
Body-drain diode reverse recovery charge	Qrr	—	1.3	—	μC	diF/dt = 100 A/µs
Note: 4. Pulse test						

Note: 4. Pulse test

Package Dimensions



Cautions

- 1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
- 2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- 3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
- 4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as failsafes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
- 5. This product is not designed to be radiation resistant.
- 6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
- 7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

ΙΙΤΔCΗ

Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica Europe	: http://semiconductor.hitachi.com/ : http://www.hitachi-eu.com/hel/ecg
	Asia Japan	: http://sicapac.hitachi-asia.com : http://www.hitachi.co.jp/Sicd/indx.htm

For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Germany Fax: <1>(408) 433-0223 Tel: <49> (89) 9 9180-0

Hitachi Europe GmbH Electronic Components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd.

Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel : <886>-(2)-2718-3666 Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel : <65>-538-6533/538-8577 Fax : <65>-538-6933/538-3877 URL : http://www.hitachi.com.sg

Hitachi Asia Ltd (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building. Taipei (105), Taiwan Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP URL : http://www.hitachi.com.tw

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong Tel : <852>-(2)-735-9218 Fax : <852>-(2)-730-0281 URL : http://www.hitachi.com.hk

Copyright © Hitachi, Ltd., 2000. All rights reserved. Printed in Japan. Colophon 2.0

HITACHI